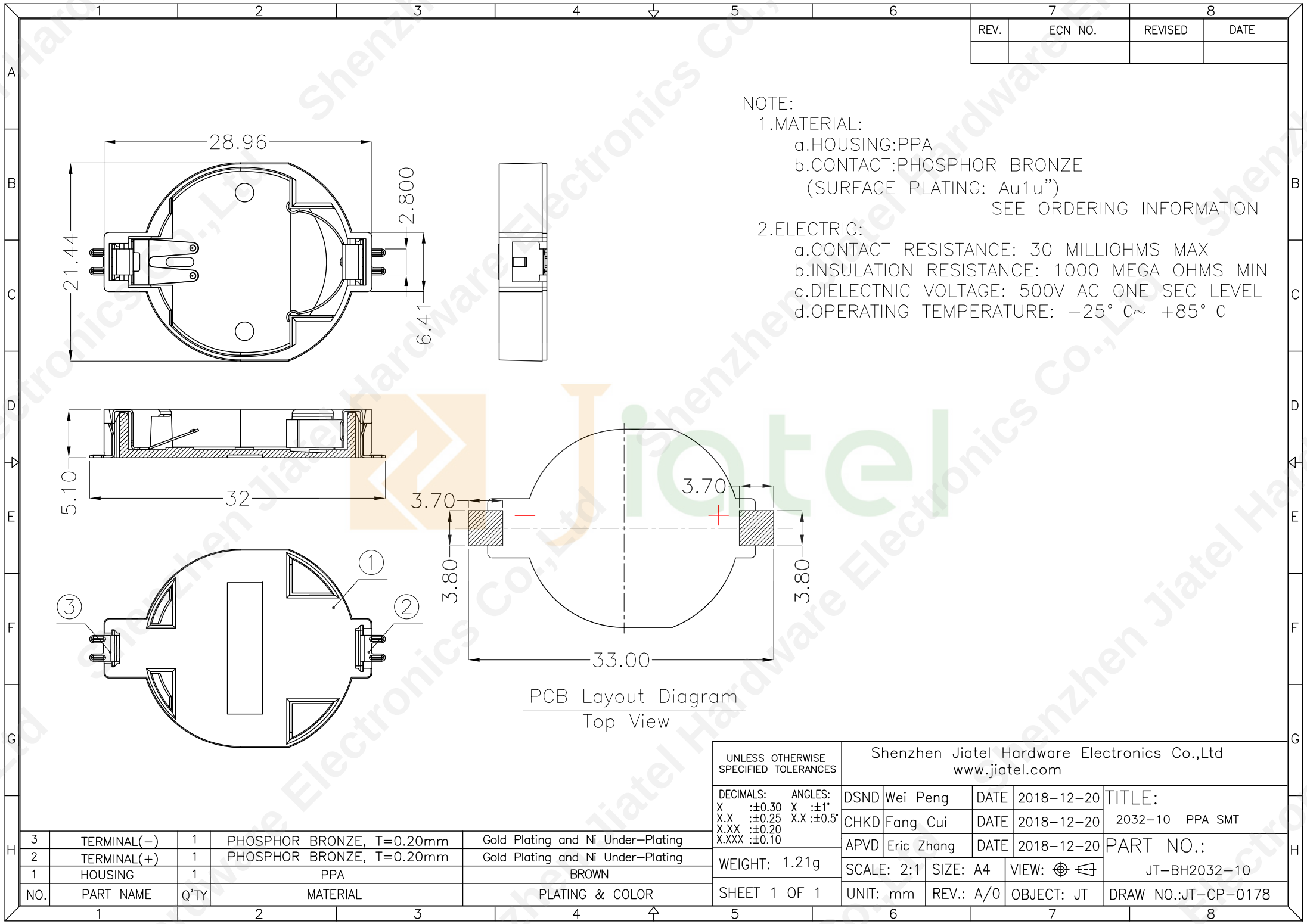




NOTE:
1.MATERIAL:
a.HOUSING:PPA
b.CONTACT:PHOSPHOR BRONZE
(SURFACE PLATING: Au1u")
SEE ORDERING INFORMATION
2.ELECTRIC:
a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN
c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL
d.OPERATING TEMPERATURE: -25° C~ +85° C

PCB Layout Diagram
Top View

UNLESS OTHERWISE SPECIFIED TOLERANCES					Shenzhen Jiatel Hardware Electronics Co.,Ltd www.jiatel.com			
DECIMALS:		ANGLES:		DSND	Wei Peng	DATE	2018-12-20	TITLE: 2032-10 PPA SMT
X :±0.30		X :±1°		CHKD	Fang Cui	DATE	2018-12-20	
X.X :±0.25		X.X :±0.5°		APVD	Eric Zhang	DATE	2018-12-20	PART NO.: JT-BH2032-10
X.XX :±0.20				WEIGHT: 1.21g		SCALE: 2:1	SIZE: A4	VIEW:
X.XXX :±0.10				SHEET 1 OF 1		UNIT: mm	REV.: A/0	OBJECT: JT
								DRAW NO.:JT-CP-0178

3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
1	HOUSING	1	PPA	BROWN
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR